## SEMICONDUCTOR FGH40T120SMD / FGH40T120SMD\_F155 1200 V, 40 A FS Trench IGBT

## Features

- FS Trench Technology, Positive Temperature Coefficient
- High Speed Switching

FAIRCHILD

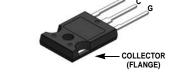
- Low Saturation Voltage: V<sub>CE(sat)</sub> =1.8 V @ I<sub>C</sub> = 40 A
- 100% of the Parts tested for I<sub>LM</sub>(1)
- · High Input Impedance
- RoHS Compliant

## Applications

• Solar Inverter, Welder, UPS & PFC applications.



Using innovative field stop trench IGBT technology, Fairchild®'s new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		Ratings	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		1200	V
V <sub>GES</sub>	Gate to Emitter Voltage		±25	V
	Transient Gate to Emitter Voltage		±30	V
1.	Collector Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	80	A
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	A
I <sub>LM</sub> (1)	Clamped Inductive Load Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	160	A
I <sub>CM</sub> (2)	Pulsed Collector Current		160	A
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 25 <sup>o</sup> C	80	A
	Diode Continuous Forward Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	A
I <sub>FM</sub>	Diode Maximum Forward Current		240	А
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	555	W
	Maximum Power Dissipation	@ T <sub>C</sub> = 100 <sup>o</sup> C	277	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	ls	300	°C

## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case		0.27	°C/W
$R_{\theta JC}$ (Diode)	HJC(Diode) Thermal Resistance, Junction to Case		0.89	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient		40	°C/W

Notes:

1. Vcc = 600 V,V\_{GE} = 15 V, I\_C = 160 A, R\_G = 10  $\odot$  . Inductive Load 2. Limited by Tjmax

Device Marking		Device	Package	Reel Size	Tape Width		Quantity 30	
FGH40T120SMD		FGH40T120SMD	TO-247 A03	-	-			
FGH40T120SMD FGH40T120SMD_F155		TO-247G03	-	-		30		
Electric	al Cha	racteristics of the	<b>IGBT</b> T <sub>C</sub> = 25°C	unless otherwise noted				
Symbol	Symbol Parameter		Test Co	Test Conditions		Тур.	Max.	Unit
Off Charac	teristics							
BV <sub>CES</sub>	Collector	to Emitter Breakdown Voltag	$V_{GE} = 0 V, I_C =$	250 uA	1200	-	-	V
I <sub>CES</sub>	Collector	Cut-Off Current	$V_{CE} = V_{CES}, V$	<sub>GE</sub> = 0 V	-	-	250	uA
I <sub>GES</sub>	G-E Leak	age Current	$V_{GE} = V_{GES}, V$	<sub>CE</sub> = 0 V	-	-	±400	nA
On Charac	teristics							
V <sub>GE(th)</sub>		shold Voltage	I <sub>C</sub> = 40 mA, V <sub>C</sub>	E = V <sub>GE</sub>	4.9	6.2	7.5	V
			$T_{\rm C} = 25^{\rm o}{\rm C}$	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V}$ $T_{C} = 25^{\circ}\text{C}$		1.8	2.4	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage		<sup>e</sup> I <sub>C</sub> = 40 A, V <sub>GE</sub> T <sub>C</sub> = 175°C	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$		2.0	-	V
Dynamic C	haracteris	stics						
C <sub>ies</sub>	Input Cap	pacitance			-	4300	-	pF
C <sub>oes</sub>	Output Capacitance		V <sub>CE</sub> = 30 V <sub>,</sub> V <sub>G</sub> f = 1MHz	$V_{CE} = 30 V, V_{GE} = 0 V,$	-	180	-	pF
C <sub>res</sub>	Reverse	Transfer Capacitance				100	-	pF
Switching	Characcte	ristics						
t <sub>d(on)</sub>		n Delay Time			-	40	-	ns
t <sub>r</sub>	Rise Time					47	-	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time	V <sub>CC</sub> = 600 V, I <sub>0</sub>	a = 40 A	-	475	-	ns
t <sub>f</sub>	Fall Time		R <sub>G</sub> = 10 Ω, V <sub>G</sub>	<sub>=</sub> = 15 V,	-	10	-	ns
E <sub>on</sub>	Turn-On	Switching Loss	Inductive Load	, T <sub>C</sub> = 25°C	-	2.7	-	mJ
E <sub>off</sub>	Turn-Off	Switching Loss			-	1.1	-	mJ
E <sub>ts</sub>	Total Swi	tching Loss			-	3.8	-	mJ
t <sub>d(on)</sub>		Delay Time			-	40	-	ns
t <sub>r</sub>	Rise Time	9			-	55	-	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time	V <sub>CC</sub> = 600 V, I <sub>0</sub>	~ = 40 A,	-	520	-	ns
t <sub>f</sub>	Fall Time		R <sub>G</sub> = 10 Ω, V <sub>G</sub>	<sub>E</sub> = 15 V,	-	50	-	ns
E <sub>on</sub>	Turn-On	Switching Loss	Inductive Load, $T_C = 175^{\circ}C$		-	3.4	-	mJ
E <sub>off</sub>	Turn-Off	Switching Loss			-	2.5	-	mJ
E <sub>ts</sub>	Total Swi	tching Loss			-	5.9	-	mJ
Q <sub>g</sub>	Total Gat	e Charge			-	370	-	nC
Q <sub>ge</sub>		mitter Charge	$V_{CE} = 600 \text{ V}, \text{ I}_{CE}$	<sub>c</sub> = 40 A,	-	23	-	nC
Q <sub>gc</sub>		collector Charge	V <sub>GE</sub> = 15 V					nC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 40 A, T <sub>C</sub> = 25 <sup>o</sup> C	-	3.8	4.8	V
		I <sub>F</sub> = 40 A, T <sub>C</sub> = 175°C	-	2.7	-	V
t <sub>rr</sub>	Diode Reverse Recovery Time	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$	-	65	-	ns
I <sub>rr</sub>	Diode Peak Reverse Recovery Current	$di_F/dt = 200 A/us, T_C = 25^{\circ}C$	-	7.2	-	А
Q <sub>rr</sub>	Diode Reverse Recovery Charge		-	234	-	nC
t <sub>rr</sub>	Diode Reverse Recovery Time	$V_{R} = 600 \text{ V}, I_{F} = 40 \text{ A},$	-	200	-	ns
I <sub>rr</sub>	Diode Peak Reverse Recovery Current	$di_{F}/dt = 200 \text{ A/us}, T_{C} = 175^{\circ}C$	-	18.0	-	А
Q <sub>rr</sub>	Diode Reverse Recovery Charge	Ť	-	1800	-	nC

## Electrical Characteristics of the DIODE $T_{C} = 25^{\circ}C$ unless otherwise noted

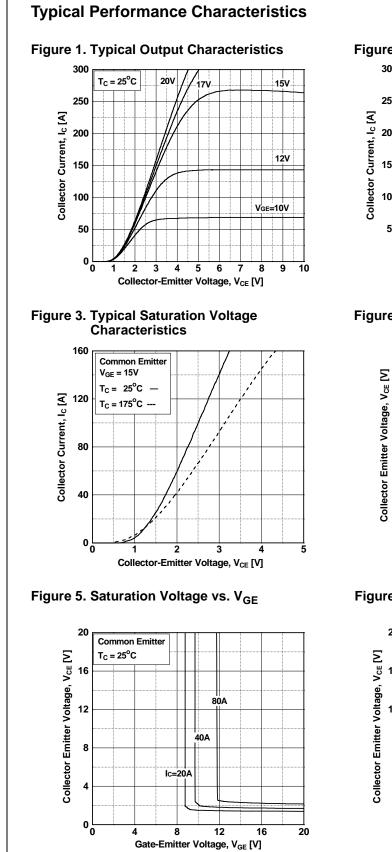
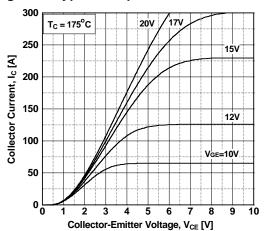
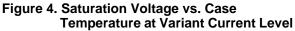


Figure 2. Typical Output Characteristics





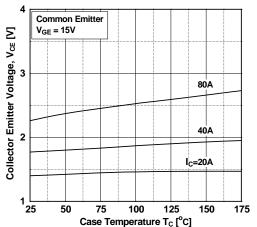
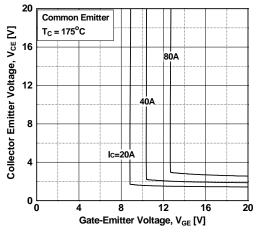


Figure 6. Saturation Voltage vs.  $V_{GE}$ 



T<sub>C</sub> = 100°C

100k

40

50

60

t<sub>d(on)</sub>

Common Emitter

= 25°C \_\_\_\_

= 175°C -Tc

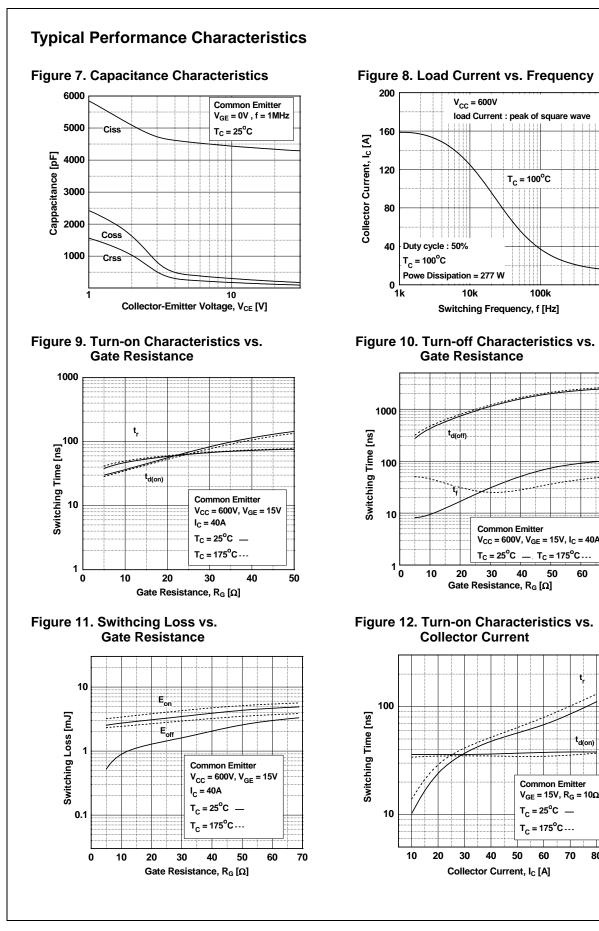
60

50

 $V_{GE} = 15V, R_G = 10\Omega$ 

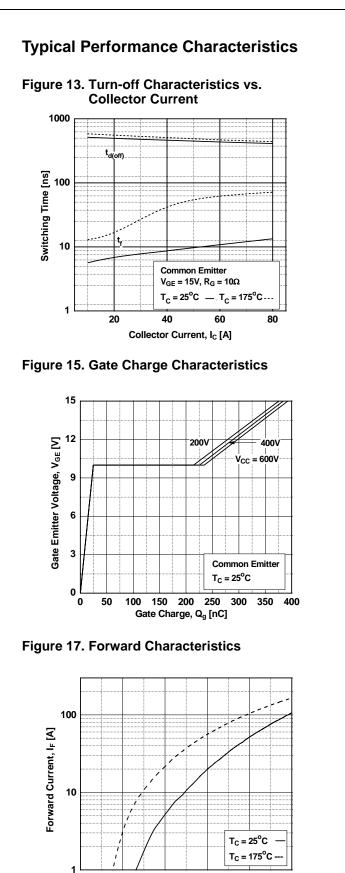
70 80 70

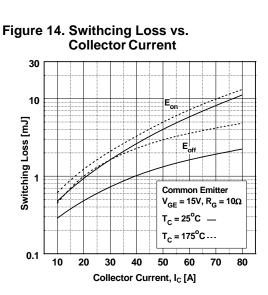
1M



www.fairchildsemi.com

©2013 Fairchild Semiconductor Corporation FGH40T120SMD / FGH40T120SMD\_F155 Rev. C2





**Figure 16. SOA Characteristics** 

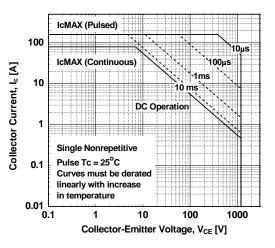
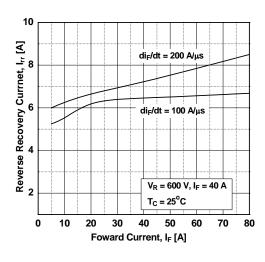


Figure 18. Reverse Recovery Current



1

0

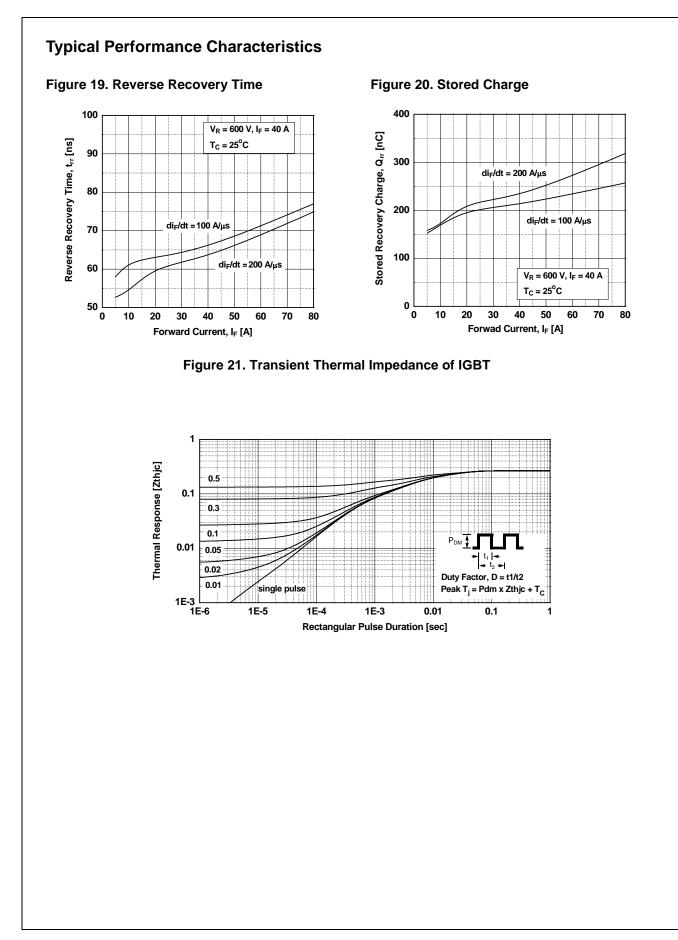
2

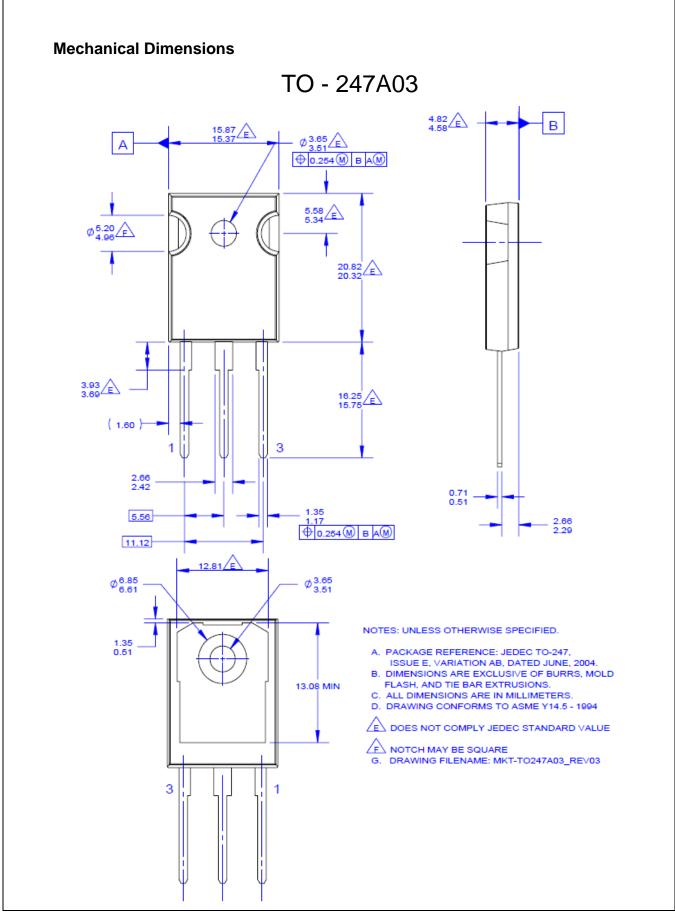
Forward Voltage, V<sub>F</sub> [V]

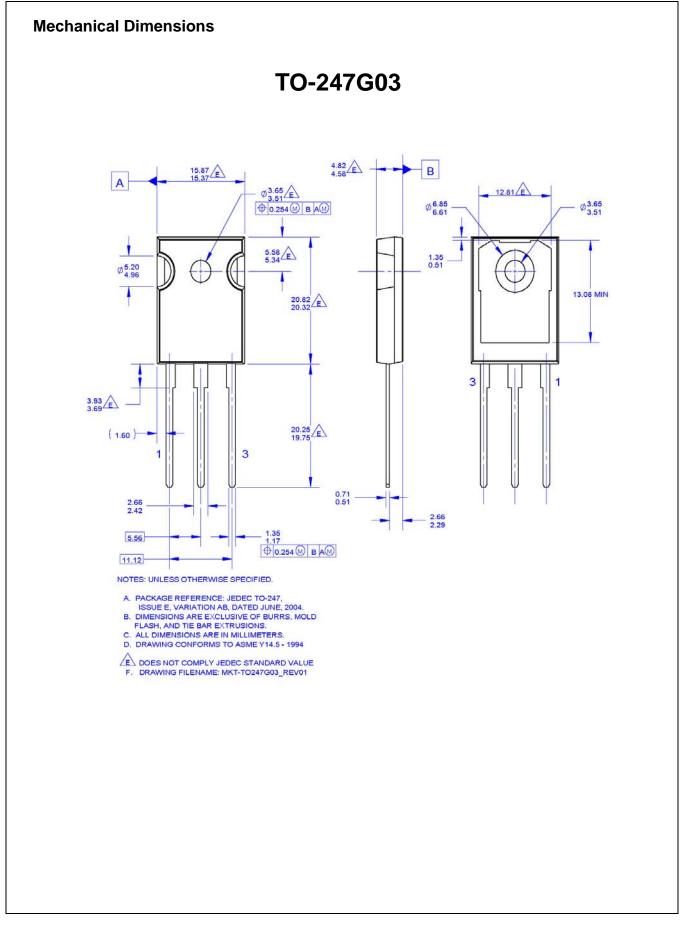
3

4

5









SEMICONDUCTOE

#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™ AccuPower™ AX-CAP® BitSiC™ Build it Now™ CorePLUS™ CorePOWER™  $CROSSVOLT^{\text{TM}}$ CTL™ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK<sup>®</sup> EfficentMax™ ESBC™ R

Fairchild® Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FastvCore™ FETBench™

FPS™ F-PFS™ FRFET® Global Power Resource<sup>SM</sup> Green Bridge™ Green FPS™ Green FPS<sup>™</sup> e-Series<sup>™</sup> Gmax™ GTO™ IntelliMAX™ ISOPLANAR™ Marking Small Speakers Sound Louder and Better™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver™ OptoHiT™ OPTOLOGIC<sup>®</sup> **OPTOPLANAR<sup>®</sup>** 

® PowerTrench<sup>®</sup> PowerXS™ Programmable Active Droop™ OFFT QS™ Quiet Series™ RapidConfigure™ тм Saving our world, 1mW/W/kW at a time™ SignalWise<sup>™</sup> SmartMax™ SMART START™ Solutions for Your Success™ SPM® STEALTH™ SuperFET<sup>®</sup> SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™

Sync-Lock™ TinvBoost TinyBuck™ TinyCalc™ TinyLogic<sup>®</sup> TINYOPTOT TinyPower™ TinyPWM™ TinyWire™ TranSiC<sup>®</sup> TriFault Detect™ TRUECURRENT® µSerDes™  $\mathcal{M}_{\text{Ser}}$ UHC® Ultra FRFET™ UniFFT™ VCX™

FGH40T120SMD / FGH40T120SMD\_F155 1200 V, 40 A FS Trench IGBT

VisualMax™ VoltagePlus™ XS™

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

### PRODUCT STATUS DEFINITIONS

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FGH40T120SMD FGH40T120SMD\_F155